Declaration of Change Description

We, HMD Global Oy, hereby declare for mobile phone TA-1391:

Model Name	Sim Card Support	SW Version	HW Version	Band
TA-1391	Single Sim	1.260_A01	19545_1_10	GSM: 850,900,1900 WCDMA 2,4,5,8 LTE 2,4,5,7,8,28 HMD RF Class B+ CAT 4.

METHOD OF IDENTIFICATION:

The chip can be distinguished from marking.





Description of Change:

Wafer fabrication process changed from 28nm to 22nm.

IMPACT OF CHANGE:

HW: Hardware reference design unchanged, chip PIN to PIN, Datasheet updated; SW:

- 1. Android A10/11 provides common Patch upgrade, SC9863A1 and SC9863A software engineering;
- 2 Android A12 provides a baseline version (compatible with SC9863A1 and SC9863A);
- 3. Update the WCN configuration document.

TA-1391 change SOC from SC9863A to SC9863A1. There are no any other changes except this. And the difference between SC9863A and SC9863A1 meet the below declaration.

	DESCRIPTION				
General	The new chip component is pin-for-pin compatible. Answer:Yes				
Description					
	2. The new chip has the same basic function as the old chip, from an external perspective (internal circuitry may differ).				
	Answer:Yes				
	3. No change in radio parameters has occurred.				
	Answer:Yes				
	4. The same conditions apply when a small area (approximately the same area as the chip) of the PC is replaced with an equivalent chip.				
	Answer:Yes				

If you should have any question(s) regarding this declaration, please don't hesitate to contact us. Thank you!

Signature: _

Name: Reza Serafat

Position: GM, Global Quality & Customer Compliance

E-mail: reza.serafat@hmdglobal.com